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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicants: Seo, Seong Min; Chung, Young Suk; Paek, Jong Sik; Ku, Jae Hun;  
Yee, Jae Hak

Assignee: Amkor Technology, Inc.

Title: Semiconductor Package Including Stacked Chips

Serial No.: 09/816,599

Filing Date: March 23, 2001

Examiner: Not Yet Assigned

Group Art Unit: 2811

Docket No.: AB-1111 US

Technology Center 2600

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**POWER OF ATTORNEY BY ASSIGNEE OF ENTIRE INTEREST**

Sir:

The above-identified assignee, Amkor Technology, Inc., a Delaware corporation, hereby revokes all powers of attorney previously given and appoints the attorney(s) and/or agent(s) identified by the following Customer Number to prosecute the above-identified application and to transact all business in the United States Patent and Trademark Office in connection therewith.

Customer Number 24251



Please address all correspondence and telephone calls regarding this application to:

James E. Parsons  
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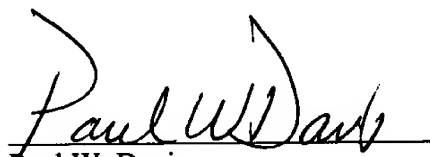
**ASSIGNEE CERTIFICATION UNDER 37 CFR 3.73(B)**

The undersigned representative of the above-identified assignee certifies that the above-identified assignee is the assignee of the entire right, title and interest in the above-identified patent application by virtue of a chain of title from the named inventors of the above-identified patent application to the above-identified assignee, as follows:

1. From co-inventors Seong Min Seo, Young Suk Chung, and Jong Sik Paek to Amkor Technology, Inc. by an Assignment, which was executed on March 15, 2001 and is recorded in the U.S. Patent and Trademark Office at Reel 011632, Frame 0832; and
2. From co-inventors Jae Hun Ku and Jae Hak Yee to Amkor Technology, Inc. by an Assignment, which was executed on January 14, 2002, and is being submitted herewith for recordation in the U.S. Patent and Trademark Office.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the above-identified assignee.

Date: Feb 15, 2002

  
Paul W. Davis  
Director of Intellectual Property

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